

INTERNATIONAL STANDARD

NORME INTERNATIONALE

Test method for erosion of wave soldering equipment using molten lead-free solder alloy –

Part 3: Selection guidance of erosion test methods

Méthode d'essai de l'érosion de l'équipement de brasage à la vague utilisant un alliage à braser sans plomb fondu –

Partie 3: Recommandations pour la sélection des méthodes d'essai d'érosion



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INTERNATIONAL ELECTROTECHNICAL COMMISSION

**TEST METHOD FOR EROSION OF WAVE SOLDERING
EQUIPMENT USING MOLTEN LEAD-FREE SOLDER ALLOY –**

Part 3: Selection guidance of erosion test methods

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International Standard IEC 62739-3 has been prepared by IEC technical committee 91: Electronics assembly technology.

The text of this International Standard is based on the following documents:

CDV	Report on voting
91/1368/CDV	91/1400/RVC

Full information on the voting for the approval of this International Standard can be found in the report on voting indicated in the above table.

This document has been drafted in accordance with the ISO/IEC Directives, Part 2.

A list of all the parts in the IEC 62739 series, under the general title *Test method for erosion of wave soldering equipment using molten lead-free solder alloy*, can be found on the IEC website.

The committee has decided that the contents of this document will remain unchanged until the stability date indicated on the IEC website under "<http://webstore.iec.ch>" in the data related to the specific document. At this date, the document will be

- reconfirmed,
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- replaced by a revised edition, or
- amended.

TEST METHOD FOR EROSION OF WAVE SOLDERING EQUIPMENT USING MOLTEN LEAD-FREE SOLDER ALLOY –

Part 3: Selection guidance of erosion test methods

1 Scope

This part of IEC 62739 describes the selection methodology of an appropriate evaluating test method for the erosion of the metal materials without or with surface processing intended to be used for lead-free wave soldering equipment as a solder bath and other components which are in contact with the molten solder.

2 Normative references

The following documents are referred to in the text in such a way that some or all of their content constitutes requirements of this document. For dated references, only the edition cited applies. For undated references, the latest edition of the referenced document (including any amendments) applies.

IEC 60068-2-20:2008, *Environmental testing – Part 2-20: Tests – Test T: Test methods for solderability and resistance to soldering heat of devices with leads*

IEC 61190-1-3, *Attachment materials for electronic assembly – Part 1-3: Requirements for electronic grade solder alloys and fluxed and non-fluxed solid solder for electronic soldering applications*

IEC 62739-1:2013, *Test method for erosion of wave soldering equipment using molten lead-free solder alloy – Part 1: Erosion test method for metal materials without surface processing*

IEC 62739-2, *Test method for erosion of wave soldering equipment using molten lead-free solder alloy – Part 2: Erosion test method for metal materials with surface processing*

3 Terms and definitions

For the purposes of this document, the following terms and definitions apply.

ISO and IEC maintain terminological databases for use in standardization at the following addresses:

- IEC Electropedia: available at <http://www.electropedia.org/>
- ISO Online browsing platform: available at <http://www.iso.org/obp>

3.1

erosion

phenomenon where a base material is dissolved and made thinner by coming into contact with molten solder

[SOURCE: IEC 62739-1:2013, 3.1]